EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L7	169	29/846.ccls. and ((semiconductor or chip or component or IC) near (structure or module))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:07
L8	41	29/846.ccls. and ((semiconductor or chip or component or IC) near (structure or module)) and mold\$3	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:07
L9	38	29/846.ccls. and ((semiconductor or chip or component or IC) near (structure or module)) and mold\$3 and (board or motherboard or PCB)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:08
L10	7	29/846.ccls. and ((semiconductor or chip or component or IC) near (structure or module)) with mold\$3 and (board or motherboard or PCB)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:09
L11	20	(29/825,829-832).ccls. and ((semiconductor or chip or component or IC) near (structure or module)) with mold\$3 and (board or motherboard or PCB)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:11
L12	7	(29/846).ccls. and ((semiconductor or chip or component or IC) near (structure or module)) with mold\$3 and (board or motherboard or PCB)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:11
L13	70	(257/686,778).ccls. and ((semiconductor or chip or component or IC) near (structure or module)) with mold\$3 and (board or motherboard or PCB)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:11
L14	24	(257/686,778).ccls. and ((semiconductor or chip or component or IC) near (structure or module)) with mold\$3 and (board or motherboard or PCB) and flexible	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:12
L15	23	(257/E25.023).ccls. and ((semiconductor or chip or component or IC) near (structure or module)) with mold\$3 and (board or motherboard or PCB) and flexible	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:14
L16	1	(264/263,272.15).ccls. and ((semiconductor or chip or component or IC) near (structure or module)) with mold\$3 and (board or motherboard or PCB) and flexible	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 19:14

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L17	5	(361/749,796,803).ccls. and	US-PGPUB;	OR	ON	2006/02/28 19:14
		((semiconductor or chip or component or IC) near (structure or module)) with mold\$3 and (board or motherboard or PCB) and flexible	USPAT; IBM_TDB			
S1	6	(("5,198,965") or ("6,285,551") or ("6,410,983") or ("6,411,921") or ("20030080438") or ("6636825")). PN.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2006/02/27 15:46
S2	0	(bradenburg-scott\$).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	-2006/02/24 18:33
S3	0	(bradenburg-scott-d).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/24 18:29
S4	7	(oman-todd\$).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/24 18:32
S5	2	(miller-micheal\$).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/24 18:32
S6	38	(brandenburg-scott\$).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/24 18:33
S7	7	(brandenburg-scott\$).in. and electronic adj module	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/27 12:35
S8	2	(oman-todd\$).in. and electronic adj module	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/27 12:36
S9	1	(miller-micheal\$).in. and electronic adj module	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/27 12:36
S10	1	("6717275").PN.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2006/02/27 15:47
S11	11	("20020000645" "20020105068" "20020109221" "5279029" "5373189" "5587341" "5677569" "5754408" "5811877" "5910885" "6153929").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/27 15:47
S12	11	("20020000645" "20020105068" "20020109221" "5279029" "5373189" "5587341" "5677569" "5754408" "5811877" "5910885" "6153929").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/27 16:38

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S13	3665	connecting adj pad	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 09:50
S14	100	((flexible or wiring) adj board) with (connecting adj pad)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 09:51
S15	23	(((flexible or wiring) adj board) with (connecting adj pad)) and connector	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 09:55
S16	9	(((flexible or wiring) adj cable) with (connecting adj pad)) and connector	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 09:56
S17	9	(((flexible or wiring or flat) adj cable) with (connecting adj pad)) and connector	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 09:56
S18	0	(((flat) adj cable) with (connecting adj pad)) and connector	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 09:56
S19	2058	(flat adj cable) with connector	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 09:57
S20	33	(flat adj cable) with pad with connector	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/28 09:57
S21	4	("4235500" "4948374" "4948379" "5213534").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/28 10:02
S22	15	("20040061221" "5151777" "5293301" "5395679" "5577656" "5923084" "6127724" "6156980" "6180045" "6180436" "6307749" "6365964" "6424529" "6424531" "6560110").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/28 16:25
S23	6	("4843520" "4868638" "5444909" "5570272" "5722161" "5935502").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/28 16:27
S24	16	("4843520").URPN.	USPAT	OR	ON	2006/02/28 16:28
S25	9	("6180045").URPN.	USPAT	OR	ON	2006/02/28 16:39
S26	6	("4843520" "4868638" "5444909" "5570272" "5722161" "5935502").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/28 16:41
S27	16	("4843520").URPN.	USPAT	OR	ON	2006/02/28 16:42
S28	1	("6717275").PN.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2006/02/28 17:21